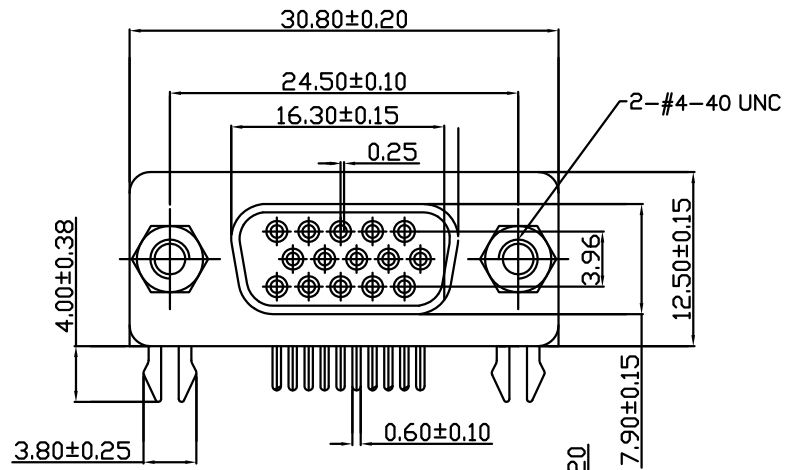


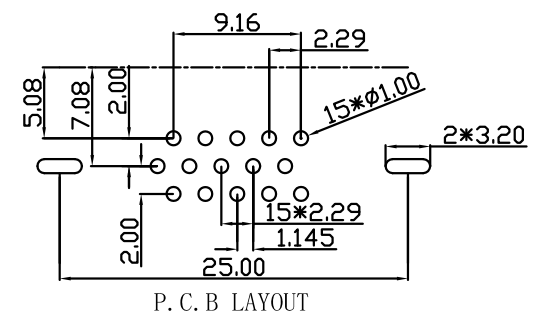
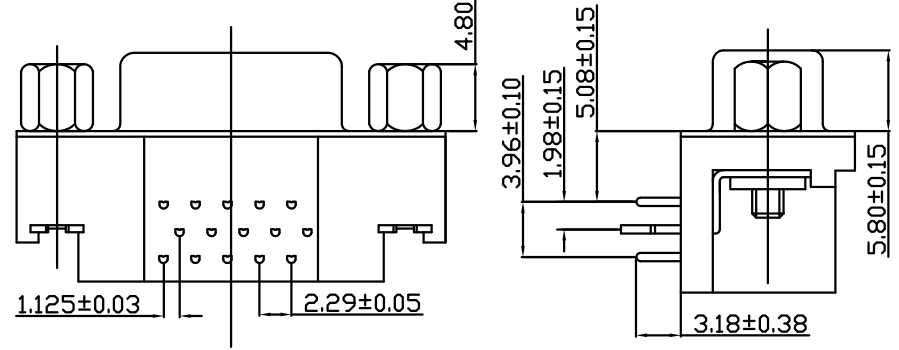
REV.	ECN.NO.	APPD.
A0	/	/



1.SPECIFICATION

- 2.1 Current Rate:5 Amps
- 2.2 Insulator Resistance:1000M Min.
- 2.3 Dielectric Strength:500V AC PER MIN
- 2.4 Operation Temperature:-55C~+105C
- 2.5 Contact Resistance:30m Max

DS111-5560-G2H8  
 G:半金G/Fu"  
 H:蓝色  
 2:PBT



TOLERANCE UNLESS OTHERWISE SPECIFIED		<b>FLW</b> 深圳市华联威电子科技有限公司			
.XXX $\pm 0.10$		HUA LIAN WEI TECHNOLOGY ELECTRONICS CO.;LTD.			
.XX $\pm 0.20$		.X' $\pm 3'$			
.X $\pm 0.30$		.XX' $\pm 2'$			
APPROVED		PART NAME:	D-SUB 15P/F 5.08 铁壳镀镍		
CHECKED		PART No:	DS111-5560-G2H8	C	
DRAWN	chenyiting	PROJECTION:	UNIT:	SCALE	SHEET
DATE	2022.05.19		mm	1:1	10F1
					REV.
					A0